

# Features

- Any frequency between 1 MHz and 80 MHz with 6 decimal places of accuracy
- 100% pin-to-pin drop-in replacement to quartz-based VCXO
- Frequency stability as tight as ±10 ppm
- Widest pull range options from ±25 ppm to ±1600 ppm
- Industrial or extended commercial temperature range
- Superior pull range linearity of ≤1%, 10 times better than quartz
- LVCMOS/LVTTL compatible output
- Four industry-standard packages: 2.5 mm x 2.0 mm (4-pin), 3.2 mm x 2.5mm (4-pin), 5.0 mm x 3.2 mm (6-pin), 7.0 mm x 5.0 mm (6-pin)
- Instant samples with Time Machine II and field programmable oscillators
- RoHS and REACH compliant, Pb-free, Halogen-free and Antimony-free

# **Electrical Specifications** Table 1. Electrical Characteristics<sup>[1, 2, 3]</sup>

# Applications

- Telecom clock synchronization, instrumentation
- Low bandwidth analog PLL, jitter cleaner, clock recovery, audio
- Video, 3G/HD-SDI, FPGA, broadband and networking



f F_stab F_aging T_use Vdd	1.71	- Frequency - - - - - - - - - - - - - - - - -	stability ar           *10           +25           +50           +5           +70           +85           and Current	MHz d Aging ppm ppm ppm ppm °C °C	Inclusive of Initial tolerance <sup>[4]</sup> at 25 °C, and variation over temperature, rated supply voltage and load. 10 years, 25°C Extended Commercial Industrial
F_stab F_aging T_use	-10 -25 -50 -5 -20 -40 <b>Supp</b> 1.71	Frequency	Stability ar           +10           +25           +50           +5           +70           +85	ppm ppm ppm ppm °C °C	Inclusive of Initial tolerance <sup>[4]</sup> at 25 °C, and variation over temperature, rated supply voltage and load. 10 years, 25°C Extended Commercial Industrial
F_aging T_use	-25 -50 -5 -20 -40 Supp 1.71	- - - - - - - - - - - - -	+10 +25 +50 +5 +70 +85	ppm ppm ppm °C °C	Inclusive of Initial tolerance <sup>[4]</sup> at 25 °C, and variation over temperature, rated supply voltage and load. 10 years, 25°C Extended Commercial Industrial
F_aging T_use	-25 -50 -5 -20 -40 Supp 1.71	– – – – bly Voltage a	+25 +50 +5 +70 +85	ppm ppm ppm °C °C	temperature, rated supply voltage and load. 10 years, 25°C Extended Commercial Industrial
T_use	-50 -5 -20 -40 <b>Supp</b> 1.71	– – – – bly Voltage a	+50 +5 +70 +85	ppm ppm °C °C	10 years, 25°C Extended Commercial Industrial
T_use	-5 -20 -40 <b>Supp</b> 1.71	– – – oly Voltage a	+5 +70 +85	ppm °C °C	Extended Commercial Industrial
T_use	-20 -40 <b>Supp</b> 1.71	– oly Voltage a	+70 +85	0° 0°	Extended Commercial Industrial
	-40 <b>Supp</b> 1.71	– oly Voltage a	+85	°C	Industrial
Vdd	<b>Supp</b> 1.71	oly Voltage a		-	
Vdd	1.71		and Current	Consum	ntion
Vdd		18			ipriori
		1.0	1.89	V	Additional supply voltages between 2.5V and 3.3V can be
	2.25	2.5	2.75	V	supported. Contact SiTime for additional information.
	2.52	2.8	3.08	V	
	2.97	3.3	3.63	V	
ldd	-	31	33	mA	No load condition, f = 20 MHz, Vdd = 2.5V, 2.8V or 3.3V
	-	29	31	mA	No load condition, f = 20 MHz, Vdd = 1.8V
I_std	-	-	70	μA	Vdd = 2.5V, 2.8V, 3.3V, ST = GND, output is Weakly Pulled Dowr
-	-	-	10	μΑ	Vdd = 1.8V, ST = GND, output is Weakly Pulled Down
		VCXO	Characteris	stics	
PR	,	, ,		ppm	See the Absolute Pull Range and APR table on page 10
VC_U	1.7	-	-	V	Vdd = 1.8V, Voltage at which maximum deviation is guaranteed
-	2.4	-	-	V	Vdd = 2.5V, Voltage at which maximum deviation is guaranteed
-	2.7	-	-	V	Vdd = 2.8V, Voltage at which maximum deviation is guaranteed
	3.2	-	-	V	Vdd = 3.3V, Voltage at which maximum deviation is guaranteed
VC_L	-	-	0.1	V	Voltage at which minimum deviation is guaranteed.
Z_in	100	-	_	kΩ	
C_in	_	5	_	pF	
Lin	_	0.1	1	%	
-	F	Positive slop	e	_	
V BW	_	8	_	kHz	Contact SiTime for 16 kHz and other high bandwidth options
	PR PR VC_U VC_L Z_in C_in Lin -	2.25           2.52           2.97           Idd         -           I_std         -           PR         ±25, ±50           ±40           VC_U         1.7           2.4         2.7           3.2         VC_L           VC_L         -           Z_in         100           C_in         -           Lin         -	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{tabular}{ c c c c c } \hline Vdd & 1.71 & 1.8 & 1.89 & V \\ \hline 2.25 & 2.5 & 2.75 & V \\ \hline 2.52 & 2.8 & 3.08 & V \\ \hline 2.97 & 3.3 & 3.63 & V \\ \hline 2.97 & 3.3 & 3.63 & V \\ \hline 1dd & - & 31 & 33 & mA \\ \hline - & 29 & 31 & mA \\ \hline - & 29 & 31 & mA \\ \hline - & 29 & 31 & mA \\ \hline - & - & 70 & \muA \\ \hline - & - & 10 & \muA \\ \hline - & - & 10 & \muA \\ \hline - & - & 10 & \muA \\ \hline VC_U & 1.7 & - & V \\ \hline 2.4 & - & - & V \\ \hline 2.7 & - & - & V \\ \hline 2.7 & - & - & V \\ \hline 2.7 & - & - & V \\ \hline 2.7 & - & - & V \\ \hline 3.2 & - & - & V \\ \hline VC_L & - & - & 0.1 & V \\ \hline VC_L & - & 5 & - & pF \\ \hline Lin & - & 0.1 & 1 & \% \\ \hline - & Positive slope & - \\ \hline \end{tabular}$



# **Electrical Specifications** (continued) Table 1. Electrical Characteristics<sup>[1, 2, 3]</sup>

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
			LVCMOS O	utput Chara	acteristic	S
Duty Cycle	DC	45	-	55	%	All Vdds. Refer to Note 11 for definition of Duty Cycle
Rise/Fall Time	Tr, Tf	-	1.5	2	ns	Vdd = 1.8V, 2.5v, 2.8V or 3.3V, 10% - 90% Vdd level
Output High Voltage	VOH	90%	-	-	Vdd	IOH = -7 mA (Vdd = 3.0V or 3.3V) IOH = -4 mA (Vdd = 2.8V or 2.5V) IOH = -2 mA (Vdd = 1.8V)
Output Low Voltage	VOL	-	-	10%	Vdd	IOL = 7 mA (Vdd = 3.0V or 3.3V) IOL = 4 mA (Vdd = 2.8V or 2.5V) IOL = 2 mA (Vdd = 1.8V)
	<u> </u>		Input	Characteris	stics	
Input Pull-up Impedance	Z_in	-	100	250	kΩ	For the OE/ST pin for 6-pin devices
Input Capacitance	C_in	-	5	-	pF	For the OE/ST pin for 6-pin devices
			Startup a	nd Resume	Timing	
Startup Time	T_start	-	-	10	ms	See Figure 7 for startup resume timing diagram
OE Enable/Disable Time	T_oe	-	-	180	ns	f = 40 MHz, all Vdds. For other freq, T_oe = 100 ns + 3 clock periods
Resume Time	T_resume	-	7	10	ms	See Figure 8 for resume timing diagram
	· · ·		•	Jitter		•
RMS Period Jitter	T_jitt	-	1.5	2	ps	f = 20 MHz, Vdd = 2.5V, 2.8V or 3.3V
		-	2	3	ps	f = 20 MHz, Vdd = 1.8V
RMS Phase Jitter (random)	T_phj	-	0.5	1	ps	f = 20 MHz, Integration bandwidth = 12 kHz to 20 MHz, All Vdds

#### Notes:

1. All electrical specifications in the above table are specified with 15 pF output load and for all Vdd(s) unless otherwise stated.

2. The typical value of any parameter in the Electrical Characteristics table is specified for the nominal value of the highest voltage option for that parameter and at 25°C temperature.

3. All max and min specifications are guaranteed across rated voltage variations and operating temperature ranges, unless specified otherwise

4. Initial tolerance is measured at Vin = Vdd/2

5. Absolute Pull Range (APR) is defined as the guaranteed pull range over temperature and voltage.

6. APR = pull range (PR) - frequency stability (F\_stab) - Aging (F\_aging)



# Table 2. Pin Description. 4-Pin Configuration

### (For 2.5 x 2.0 mm and 3.2 x 2.5 mm packages)

Pin	Symbol	Functionality			
1	VIN	Input	0-Vdd: produces voltage dependent frequency change		
2	GND	Power	Electrical ground		
3	CLK	Output	Oscillator output		
4	VDD	Power	Power supply voltage <sup>[7]</sup>		



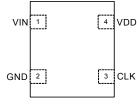


Figure 1.

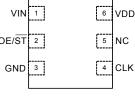
#### Note:

7. A capacitor value of 0.1 µF between VDD and GND is recommended.

# Table 3. Pin Description. 6-Pin Configuration (For 5.0 x 3.2 mm and 7.0 x 5.0 mm packages)

Pin	Symbol		Functionality	
1	VIN	Input	0-Vdd: produces voltage dependent frequency change	
		No Connect	H or L or Open: No effect on output frequency or other device functions	
2	NC/OE/ ST	Output Enable	H or Open <sup>[8]</sup> : specified frequency output L: output is high	VIN
		Standby	H or Open <sup>[8]</sup> : specified frequency output L: output is low (weak pull down) <sup>[9]</sup> . Oscillation stops	NC/OE/ST
3	GND	Power	Electrical ground	GND
4	CLK	Output	Oscillator output	
5	NC	No Connect	H or L or Open: No effect on output frequency or other device functions	
6	VDD	Power	Power supply voltage <sup>[10]</sup>	

# Top View



### Figure 2.

#### Notes:

8. In OE or ST mode, a pull-up resistor of 10 kΩ or less is recommended if pin 2 in the 6-pin package is not externally driven. If pin 2 needs to be left floating, use the NC option

9. Typical value of the weak pull-down impedance is 5 m $\!\Omega$ 

10. A capacitor value of 0.1  $\mu F$  between VDD and GND is recommended.

# Table 4. Absolute Maximum Limits

Attempted operation outside the absolute maximum ratings may cause permanent damage to the part. Actual performance of the IC is only guaranteed within the operational specifications, not at absolute maximum ratings.

Parameter	Min.	Max.	Unit
Storage Temperature	-65	150	°C
VDD	-0.5	4	V
Electrostatic Discharge	-	2000	V
Soldering Temperature (follow standard Pb free soldering guidelines)	-	260	°C

### Table 5. Thermal Consideration

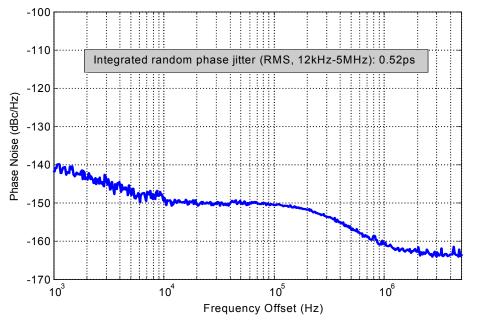
Parameter	θJA, 4 Layer Board (°C/W)	θJA, 2 Layer Board (°C/W)	θJC, Bottom (°C/W)
7050	191	263	30
5032	97	199	24
3225	109	212	27
2520	117	222	26

### Table 6. Environmental Compliance

Parameter	Condition/Test Method
Mechanical Shock	MIL-STD-883F, Method 2002
Mechanical Vibration	MIL-STD-883F, Method 2007
Temperature Cycle	JESD22, Method A104
Solderability	MIL-STD-883F, Method 2003
Moisture Sensitivity Level	MSL1 @ 260°C



# **Phase Noise Plot**





# **Test Circuit and Waveform**

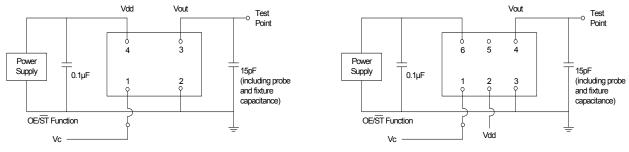


Figure 4. Test Circuit (4-Pin Device)



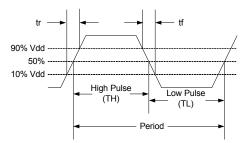


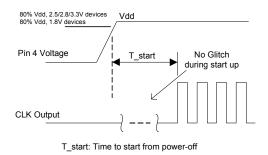
Figure 6. Waveform

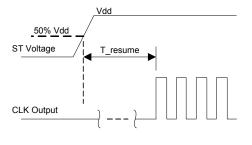
### Note:

- 11. Duty Cycle is computed as Duty Cycle = TH/Period.
- 12. SiT3808 supports the configurable duty cycle feature. For custom duty cycle at any given frequency, contact SiTime.



# **Timing Diagram**





T\_resume: Time to resume from ST

50% Vdd

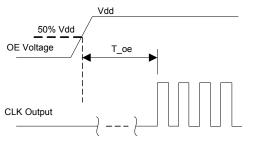
T\_oe

Figure 8. Standby Resume Timing (ST Mode Only)

Vdd

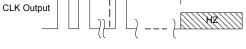
OE Voltage

# Figure 7. Startup Timing (OE/ST Mode)



T\_oe: Time to re-enable the clock output

### Figure 9. OE Enable Timing (OE Mode Only)



T\_oe: Time to put the output in High Z mode

### Figure 10. OE Disable Timing (OE Mode Only)

#### Notes:

13. SiT3808 supports "no runt" pulses and "no glitch" output during startup or resume.

14. SiT3808 supports gated output which is accurate within rated frequency stability from the first cycle.



# **Programmable Drive Strength**

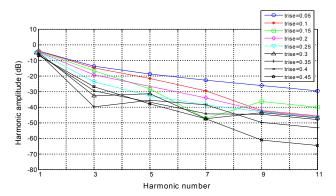
The SiT3808 includes a programmable drive strength feature to provide a simple, flexible tool to optimize the clock rise/fall time for specific applications. Benefits from the programmable drive strength feature are:

- Improves system radiated electromagnetic interference (EMI) by slowing down the clock rise/fall time.
- Improves the downstream clock receiver's (RX) jitter by decreasing (speeding up) the clock rise/fall time.
- Ability to drive large capacitive loads while maintaining full swing with sharp edge rates.

For more detailed information about rise/fall time control and drive strength selection, see the SiTime Application Notes section; <u>http://www.sitime.com/support/application-notes.</u>

### EMI Reduction by Slowing Rise/Fall Time

Figure 11 shows the harmonic power reduction as the rise/fall times are increased (slowed down). The rise/fall times are expressed as a ratio of the clock period. For the ratio of 0.05, the signal is very close to a square wave. For the ratio of 0.45, the signal is very close to near-triangular waveform. These results, for example, show that the 11th clock harmonic can be reduced by 35 dB if the rise/fall edge is increased from 5% of the period to 45% of the period.



### Figure 11. Harmonic EMI reduction as a Function of Slower Rise/Fall Time

### **Jitter Reduction with Faster Rise/Fall Time**

Power supply noise can be a source of jitter for the downstream chipset. One way to reduce this jitter is to increase rise/fall time (edge rate) of the input clock. Some chipsets would require faster rise/fall time in order to reduce their sensitivity to this type of jitter. Refer to the Rise/Fall Time Tables to determine the proper drive strength.

### **High Output Load Capability**

The rise/fall time of the input clock varies as a function of the actual capacitive load the clock drives. At any given drive strength, the rise/fall time becomes slower as the output load increases. As an example, for a 3.3V SiT3808 device with default drive strength setting, the typical rise/fall time is 1.15 ns for 15 pF output load. The typical rise/fall time slows down to 2.72 ns when the output load increases to 45 pF. One can choose to speed up the rise/fall time to 1.41 ns by then

increasing the drive strength setting to "P" (reference to the drive strength code in Table 10) on the SiT3808.

The SiT3808 can support up to 60 pF maximum capacitive loads. Refer to the Rise/Tall Time Tables to determine the proper drive strength for the desired combination of output load vs. rise/fall time.

### SiT3808 Drive Strength Selection

Tables 7 through 10 define the rise/fall times for a given capacitive load and supply voltage.

- 1. Select the table that matches the SiT3808 nominal supply voltage (1.8V, 2.5V, 2.8V, 3.3V).
- 2. Select the capacitive load column that matches the application requirement (5 pF to 60 pF)
- 3. Under the capacitive load column, select the desired rise/fall times.
- 4. The left-most column represents the part number code for the corresponding drive strength.
- 5. Add the drive strength code to the part number for ordering purposes.

### **Calculating Maximum Frequency**

Based on the rise and fall time data given in Tables 7 through 10, the maximum frequency the oscillator can operate with guaranteed full swing of the output voltage over temperature can be calculated as follows:

Max Frequency = 
$$\frac{1}{6 \times \text{Trf}_{10/90}}$$

Where Trf\_10/90 is the typical rise/fall time at 10% to 90% Vdd.

### <u>Example 1</u>

Calculate f<sub>MAX</sub> for the following condition:

- Vdd = 3.3V (Table 10)
- Capacitive Load: 30 pF
- Typical Tr/f time = 1.66 ns (drive strength part number code = G)

Part number for the above example: SiT3808AI**G**G2-33EH-49.152000

Drive strength code is inserted here. Default setting is "-"



# Rise/Fall Time (10% to 90%) vs $\rm C_{\rm LOAD}$ Tables

Table 7. Vdd = 1.8V Rise/Fall Times for Specific C<sub>LOAD</sub>

	Rise/Fall Time Typ (ns)					
Drive Strength \ C <sub>LOAD</sub>	5 pF	15 pF	30 pF	45 pF	60 pF	
L	12.45	17.68	19.48	46.21	57.82	
Α	6.50	10.27	16.21	23.92	30.73	
R	4.38	7.05	11.61	16.17	20.83	
В	3.27	5.30	8.89	12.18	15.75	
S	2.62	4.25	7.20	9.81	12.65	
D	2.19	3.52	6.00	8.31	10.59	
Т	1.76	3.01	5.14	7.10	9.15	
E	1.59	2.59	4.49	6.25	7.98	
U	1.49	2.28	3.96	5.55	7.15	
F	1.22	2.10	3.57	5.00	6.46	
W	1.07	1.88	3.23	4.50	5.87	
G	1.01	1.64	2.95	4.12	5.40	
X	0.96	1.50	2.74	3.80	4.98	
К	0.92	1.41	2.56	3.52	4.64	
Y	0.88	1.34	2.39	3.25	4.32	
Q	0.86	1.29	2.24	3.04	4.06	
Z or "-": Default	0.82	1.24	2.07	2.89	3.82	
М	0.77	1.20	1.94	2.72	3.61	
N	0.66	1.15	1.84	2.58	3.41	
Р	0.51	1.09	1.76	2.45	3.24	

	Rise/Fall Time Typ (ns)					
Drive Strength \ C <sub>LOAD</sub>	5 pF	15 pF	30 pF	45 pF	60 pF	
L	8.68	13.59	18.36	32.70	42.06	
Α	4.42	7.18	11.93	16.60	21.38	
R	2.93	4.78	8.15	11.19	14.59	
В	2.21	3.57	6.19	8.55	11.04	
S	1.67	2.87	4.94	6.85	8.80	
D	1.50	2.33	4.11	5.68	7.33	
Т	1.06	2.04	3.50	4.84	6.26	
E	0.98	1.69	3.03	4.20	5.51	
U	0.93	1.48	2.69	3.73	4.92	
F	0.90	1.37	2.44	3.34	4.42	
W	0.87	1.29	2.21	3.04	4.02	
G or "-": Default	0.67	1.20	2.00	2.79	3.69	
Х	0.44	1.10	1.86	2.56	3.43	
К	0.38	0.99	1.76	2.37	3.18	
Y	0.36	0.83	1.66	2.20	2.98	
Q	0.34	0.71	1.58	2.07	2.80	
Z	0.33	0.65	1.51	1.95	2.65	
М	0.32	0.62	1.44	1.85	2.50	
Ν	0.31	0.59	1.37	1.77	2.39	
Р	0.30	0.57	1.29	1.70	2.28	

## Table 8. Vdd = 2.5V Rise/Fall Times for Specific C<sub>LOAD</sub>

### Table 9. Vdd = 2.8V Rise/Fall Times for Specific C<sub>LOAD</sub>

Rise/Fall Time Typ (ns)					
Drive Strength \ C <sub>LOAD</sub>	5 pF	15 pF	30 pF	45 pF	60 pF
L	7.93	12.69	17.94	30.10	38.89
Α	4.06	6.66	11.04	15.31	19.80
R	2.68	4.40	7.53	10.29	13.37
В	2.00	3.25	5.66	7.84	10.11
S	1.59	2.57	4.54	6.27	8.07
D	1.19	2.14	3.76	5.21	6.72
Т	1.00	1.79	3.20	4.43	5.77
E	0.94	1.51	2.78	3.84	5.06
U	0.90	1.38	2.48	3.40	4.50
F	0.87	1.29	2.21	3.03	4.05
W	0.62	1.19	1.99	2.76	3.68
G or "-": Default	0.41	1.08	1.84	2.52	3.36
Х	0.37	0.96	1.72	2.33	3.15
К	0.35	0.78	1.63	2.15	2.92
Y	0.33	0.67	1.54	2.00	2.75
Q	0.32	0.63	1.46	1.89	2.57
Z	0.31	0.60	1.39	1.80	2.43
М	0.30	0.57	1.31	1.72	2.30
N	0.30	0.56	1.22	1.63	2.22
Р	0.29	0.54	1.13	1.55	2.13

Table 10. Vdd = 3.3V Rise/Fall Times for Specific C<sub>LOAD</sub>

	Rise/Fall Time Typ (ns)					
Drive Strength \ C <sub>LOAD</sub>	5 pF	15 pF	30 pF	45 pF	60 pF	
L	7.18	11.59	17.24	27.57	35.57	
Α	3.61	6.02	10.19	13.98	18.10	
R	2.31	3.95	6.88	9.42	12.24	
В	1.65	2.92	5.12	7.10	9.17	
S	1.43	2.26	4.09	5.66	7.34	
D	1.01	1.91	3.38	4.69	6.14	
Т	0.94	1.51	2.86	3.97	5.25	
E	0.90	1.36	2.50	3.46	4.58	
U	0.86	1.25	2.21	3.03	4.07	
F or "-": Default	0.48	1.15	1.95	2.72	3.65	
W	0.38	1.04	1.77	2.47	3.31	
G	0.36	0.87	1.66	2.23	3.03	
Х	0.34	0.70	1.56	2.04	2.80	
К	0.33	0.63	1.48	1.89	2.61	
Y	0.32	0.60	1.40	1.79	2.43	
Q	0.32	0.58	1.31	1.69	2.28	
Z	0.30	0.56	1.22	1.62	2.17	
М	0.30	0.55	1.12	1.54	2.07	
N	0.30	0.54	1.02	1.47	1.97	
Р	0.29	0.52	0.95	1.41	1.90	



# Instant Samples with Time Machine and Field Programmable Oscillators

SiTime supports a field programmable version of the SiT3808 low power oscillator for fast prototyping and real time customization of features. The <u>field programmable devices</u> (FP devices) are available for all four standard SiT3808 package sizes and can be configured to one's exact specification using the <u>Time Machine II</u>, an USB powered MEMS oscillator programmer.

Customizable Features of the SiT3808 FP Devices Include

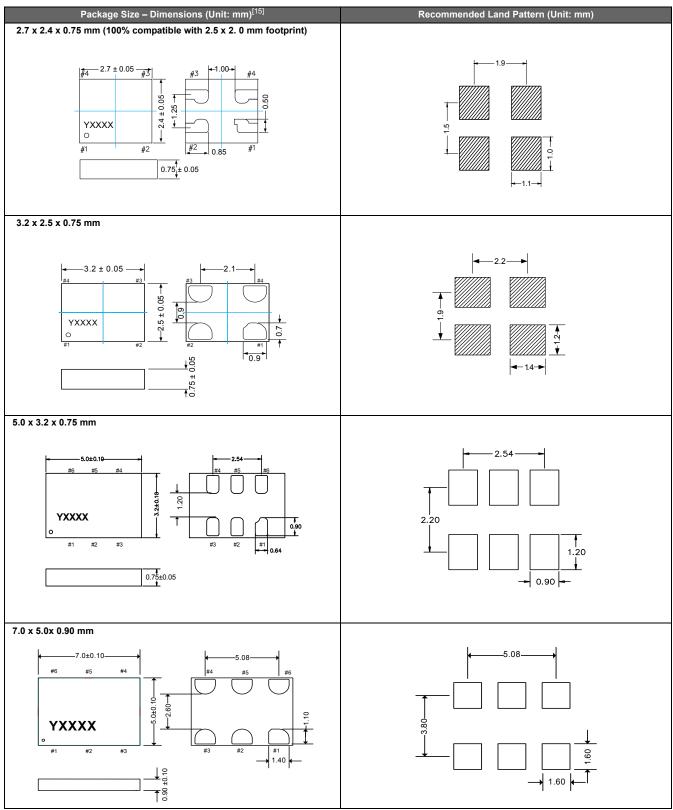
- Any frequency between 1 and 80 MHz
- Three frequency stability options: ±10 ppm, ±25 ppm, ±50 ppm
- Two operating temperatures: -20 to 70°C or -40 to 85°C
- Four supply voltage options: 1.8V, 2.5V, 2.8V, and 3.3V
- Eight pull range options: ±25 ppm, ±50 ppm, ±100 ppm, ±150 ppm, ±200 ppm, ±400 ppm, ±800 ppm, ±1600 ppm

For more information regarding SiTime's field programmable solutions, visit <u>http://www.sitime.com/time-machine</u> and <u>http://www.sitime.com/fp-devices</u>.

SiT3808 is typically factory-programmed per customer ordering codes for volume delivery.



# **Dimensions and Patterns**



#### Note:

15. Top marking: Y denotes manufacturing origin and XXXX denotes manufacturing lot number. The value of "Y" will depend on the assembly location of the device.



# **Ordering Information**

Part Family "SiT3808"	Packing Method "T": 12 mm Tape & Reel, 3ku reel "Y": 12 mm Tape & Reel, 1ku reel
Revision Letter "A" is the revision	"D": 8 mm Tape & Reel, 3ku reel "E": 8 mm Tape & Reel, 1ku reel Blank for Bulk
Temperature Range "C" Commercial, -20 to 70°C	Frequency 1.000000 to 80.000000 MHz
"I" Industrial, -40 to 85°C Output Drive Strength "-" Default (datasheet limits) See rise/fall tables on page 7 "L" "S" "U" "X" "Z" "A" "D" "F" "K" "M" "R" "T" "W" "Y" "N" "B" "E" "G" "Q" "P"	Pull Range Options "M" for ±25 ppm "B" for ±50 ppm "E" for ±100 ppm "G" for ±150 ppm "H" for ±200 ppm "X" for ±400 ppm "Y" for ±800 ppm "Z" for ±1600 ppm
Package           "G"         2.5 x 2.0 mm x mm           "2"         4-pin, 3.2 x 2.5 mm x mm           "C"         6-pin, 5.0 x 3.2 mm x mm           "D"         6-pin, 7.0 x 5.0 mm x mm	Feature Pin "N" for No Connect in 6-pin devices Default value in 4-pin device "E" for Output Enable (6-pin only) "S" for Standby (6-pin only)
Frequency Stability "F" for ±10 ppm "2" for ±25 ppm "3" for ±50 ppm	Supply Voltage "18" for 1.8 V ±5% "25" for 2.5 V ±10% "28" for 2.8 V ±10% "33" for 3.3 V ±10%

# 

# Table 12. APR Definition

Absolute pull range (APR) = Norminal pull range (PR) - frequency stability (F\_stab) - Aging (F\_aging)

	Frequency Stability			
Nominal Pull Range	± 10	± 25	± 50	
		APR (PPM)		
± 25	± 10	-	_	
± 50	± 35	± 20	_	
± 100	± 85	± 70	± 45	
± 150	± 135	± 120	± 95	
± 200	± 185	± 170	± 145	
± 400	± 385	± 370	± 345	
± 800	± 785	± 770	± 745	
± 1600	± 1585	± 1570	± 1545	

# Table 13. Ordering Codes for Supported Tape & Reel Packing Method<sup>[16]</sup>

Device Size	12 mm T&R (3ku)	12 mm T&R (1ku)	8 mm T&R (3ku)	8 mm T&R 1ku)
2.5 x 2.0 mm	-	-	D	E
3.2 x 2.5 mm	-	-	D	E
5.0 x 3.2 mm	Т	Y	-	-
7.0 x 5.0 mm	Т	Y	-	_

Note:

16. "-" indicates "not available."



## Table 14. Additional Information

Document	Description	Download Link		
Manufacturing Notes	Tape & Reel dimension, reflow profile and other manufacturing related info	http://www.sitime.com/component/docman/doc_download/85-manufaturing-notes-for-sitime-oscillators		
Qualification Reports	RoHS report, reliability reports, composition reports	http://www.sitime.com/support/quality-and-reliability		
Performance Reports	Additional performance data such as phase noise, current consumption and jitter for selected frequencies	http://www.sitime.com/support/performance-measurement-report		
Termination Techniques	Termination design recommendations	http://www.sitime.com/support/application-notes		
Layout Techniques	Layout recommendations	http://www.sitime.com/support/application-notes		
VCXO Specifications	Definition of key VCXO specifications such as APR and Kv	http://www.sitime.com/support2/documents/AN10020_VCXO_SpecDefinitions_rev1.pdf		
VCXO in PLL Design	Selection of VCXO parameters and trade-offs in PLL designs	http://www.sitime.com/support2/documents/AN10021_VCXO_PLL_Design_Guidelines_1v0.pdf		

# **Revision History**

### Table 15. Datasheet Version and Change Log

Version	Release Date	Change Summary
0.6	1/24/2013	Preliminary
1.0	3/7/14	<ul> <li>Preliminary removed from title</li> <li>Updated features and application</li> <li>Updated electrical specifications table</li> <li>Updated figure 4,</li> <li>Added new 6-pin device for figure 5</li> <li>Updated timing diagrams</li> <li>Updated programmable drive strength section</li> <li>Updated ordering information drawing</li> <li>Updated APR table</li> <li>Updated ordering codes for tape and reel table</li> <li>Reformatted additional information table columns</li> </ul>
1.01	1/8/15	Corrected CLK and VDD functionality description in Table 2     Revised VIN functionality description in Table 3

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# **Supplemental Information**

The Supplemental Information section is not part of the datasheet and is for informational purposes only.



# Silicon MEMS Outperforms Quartz



### **Best Reliability**

Silicon is inherently more reliable than quartz. Unlike quartz suppliers, SiTime has in-house MEMS and analog CMOS expertise, which allows SiTime to develop the most reliable products. Figure 1 shows a comparison with quartz technology.

### Why is SiTime Best in Class:

- SiTime's MEMS resonators are vacuum sealed using an advanced EpiSeal<sup>™</sup> process, which eliminates foreign particles and improves long term aging and reliability
- · World-class MEMS and CMOS design expertise

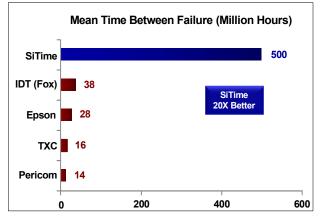


Figure 1. Reliability Comparison<sup>[1]</sup>

### Best Aging

Unlike quartz, MEMS oscillators have excellent long term aging performance which is why every new SiTime product specifies 10-year aging. A comparison is shown in Figure 2.

### Why is SiTime Best in Class:

- SiTime's MEMS resonators are vacuum sealed using an advanced EpiSeal process, which eliminates foreign particles and improves long term aging and reliability
- Inherently better immunity of electrostatically driven MEMS resonator

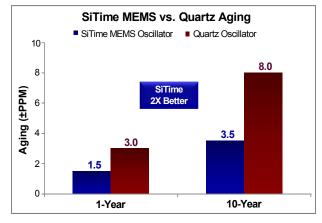


Figure 2. Aging Comparison<sup>[2]</sup>

### Best Electro Magnetic Susceptibility (EMS)

SiTime's oscillators in plastic packages are up to 54 times more immune to external electromagnetic fields than quartz oscillators as shown in Figure 3.

### Why is SiTime Best in Class:

- Internal differential architecture for best common mode noise rejection
- Electrostatically driven MEMS resonator is more immune to EMS

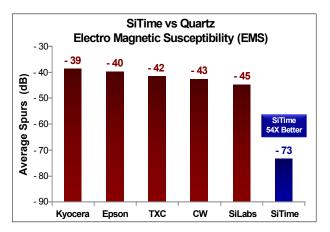


Figure 3. Electro Magnetic Susceptibility (EMS)<sup>[3]</sup>

# Best Power Supply Noise Rejection

SiTime's MEMS oscillators are more resilient against noise on the power supply. A comparison is shown in Figure 4.

### Why is SiTime Best in Class:

- On-chip regulators and internal differential architecture for common mode noise rejection
- · Best analog CMOS design expertise

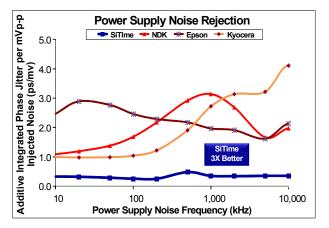


Figure 4. Power Supply Noise Rejection<sup>[4]</sup>



### **Best Vibration Robustness**

High-vibration environments are all around us. All electronics, from handheld devices to enterprise servers and storage systems are subject to vibration. Figure 5 shows a comparison of vibration robustness.

### Why is SiTime Best in Class:

- The moving mass of SiTime's MEMS resonators is up to 3000 times smaller than quartz
- Center-anchored MEMS resonator is the most robust design

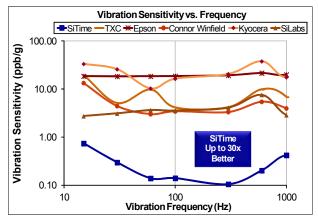


Figure 5. Vibration Robustness<sup>[5]</sup>

#### Notes:

- 1. Data Source: Reliability documents of named companies.
- 2. Data source: SiTime and quartz oscillator devices datasheets.
- 3. Test conditions for Electro Magnetic Susceptibility (EMS):
  - According to IEC EN61000-4.3 (Electromagnetic compatibility standard)
     Eicle stage stage
  - Field strength: 3V/m
  - Radiated signal modulation: AM 1 kHz at 80% depth
  - Carrier frequency scan: 80 MHz 1 GHz in 1% steps
  - Antenna polarization: Vertical
  - · DUT position: Center aligned to antenna

### Devices used in this test:

SiTime, SiT9120AC-1D2-33E156.250000 - MEMS based - 156.25 MHz Epson, EG-2102CA 156.2500M-PHPAL3 - SAW based - 156.25 MHz TXC, BB-156.250MBE-T - 3rd Overtone quartz based - 156.25 MHz Kyocera, KC7050T156.250P30E00 - SAW based - 156.25 MHz Connor Winfield (CW), P123-156.25M - 3rd overtone quartz based - 156.25 MHz SiLabs, Si590AB-BDG - 3rd overtone quartz based - 156.25 MHz

### 4. 50 mV pk-pk Sinusoidal voltage.

Devices used in this test:

SiTime, SiT8208AI-33-33E-25.000000, MEMS based - 25 MHz NDK, NZ2523SB-25.6M - quartz based - 25.6 MHz Kyocera, KC2016B25M0C1GE00 - quartz based - 25 MHz Epson, SG-310SCF-25M0-MB3 - quartz based - 25 MHz

- 5. Devices used in this test: same as EMS test stated in Note 3.
- 6. Test conditions for shock test:
- MIL-STD-883F Method 2002
- Condition A: half sine wave shock pulse, 500-g, 1ms
- Continuous frequency measurement in 100 µs gate time for 10 seconds
- Devices used in this test: same as EMS test stated in Note 3

7. Additional data, including setup and detailed results, is available upon request to qualified customers. Please contact productsupport@sitime.com.

# Best Shock Robustness

SiTime's oscillators can withstand at least 50,000 g shock. They all maintain their electrical performance in operation during shock events. A comparison with quartz devices is shown in Figure 6.

### Why is SiTime Best in Class:

- The moving mass of SiTime's MEMS resonators is up to 3000 times smaller than quartz
- Center-anchored MEMS resonator is the most robust design

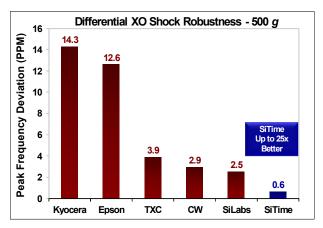


Figure 6. Shock Robustness<sup>[6]</sup>

# **Document Feedback Form**



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 SiT3701AC-43-33C-10.00000X
 315LB311250T

 CVPD-922X-100.000
 CVSS-945-125.000
 ASVV-4.096 MHz-L50-N152-T
 CVHD-950-122.880
 CVHD-950-80.000
 CVHD-950X-100.000

 CVHD950X-54.000
 CVPD-920-100.000
 ASG-P-V-A-1.000GHZ
 ECXV-P37C2M-640.000
 CVPD-920-80.000
 CVHD-957-22.57920
 ECXV 

 P37C2N-155.520
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 ECXV-P37C2N-155.000
 ECXV-P35C2N-155.520
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 CVPD-920-74.25
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 ABLNO-V-120.000MHZ

 ABLNO-V-80.000MHZ
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 ABLJO-V-120.000MHZ
 ABLJO-V-122.880MHz
 ABLJO-V-150.000MHz
 ABLJO-V 

 155.520MHZ
 ABLJO-V-160.000MHz
 ABLJO-V-200.000MHZ
 ABLJO-V-125.000MHz
 ABLNO-V-100.000MHz

 ABLNO-V-100.000MHz
 ABLJO-V-120.000MHz
 ABLJO-V-125.000MHz
 ABLNO-V-156.250MHz

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